

Title (en)
PRINTED CIRCUIT BOARD AND A METHOD FOR PRODUCING A PRINTED CIRCUIT BOARD

Title (de)
LEITERPLATTE UND VERFAHREN ZUR HERSTELLUNG EINER LEITERPLATTE

Title (fr)
CARTE DE CIRCUIT IMPRIMÉ ET SON PROCÉDÉ DE FABRICATION

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Application
EP 16722569 A 20160428

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Abstract (en)
[origin: WO2016177631A1] The invention relates to a printed circuit board (1) for an electronic component, comprising: - an electrically-insulating substrate (1.1), - a number of electrically-conductive conductor tracks (1.2), and - at least one sensor dome (S) having a sensor head (2) and a carrier body (2.1) for receiving said sensor head (2). According to the invention, the carrier body (2.1) is designed to be integral to the substrate (1.1). The invention also relates to a method for producing such a printed circuit board (1).

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H05K 3/284 (2013.01 - US); **H05K 3/303** (2013.01 - US); **H05K 3/366** (2013.01 - EP US); **H05K 5/0082** (2013.01 - EP US);
H05K 2201/09045 (2013.01 - US); **H05K 2201/10151** (2013.01 - EP US); **H05K 2201/10166** (2013.01 - EP US); **H05K 2203/302** (2013.01 - US)

Citation (search report)
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